Absolute Pressure Sensor with Analog Output Datasheet

1. Features and Benefits

- Triphibian[™] technology
- +/-0.5% full scale lifetime accuracy
- Ratiometric analog output
- Fast response time (min 0.4ms)
- System in a package: MEMS, analog frontend circuitry, 16-bit microcontroller, voltage regulators and analog ratiometric back-end
- Automotive temperature range (-40°C to 150°C)
- Robust in gas and liquid media, compliant with chemical refrigerants
- Qualified according to AEC-Q100 and AEC-Q103-002
- Configurable diagnostic features like internal broken connection, over voltage, under voltage etc.
- Factory calibrated and fully programmable through the connector with the PTC04 programming tool for customized calibration curves
- Extended over (+40V) and reverse (-40V) voltage capabilities (supply & output)
- ASIL compliant developed as an ASIL A SEOOC as per ISO 26262



2. Application Examples

- Absolute pressures from 2bar to 70bar with gas and/or liquid media
- Thermal Management of Electric Vehicles
 - Standalone sensors
 - Embedded sensors in expansion valves
 - Embedded sensors in e-compressors
 - Embedded sensors in pumps
- HVAC-R systems



Figure 1: MLX90830



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Absolute Pressure Sensor with Analog Output Datasheet

3. Ordering information

Product Code	Temperature Code	Package Code	Option Code	Packing Form Code
MLX90830	L	XZ	BAH-001	RE
MLX90830	L	XZ	BAF-002	RE

Legend:

Temperature Code:	L (-40°C to 150°C)
Package Code:	XZ = SOIC16 WB cavity facing up package
Option Code:	BAH-001 = 0 to 10.342bar (= 150PSI) absolute pressure / 0.5 to 4.5V analog output
	BAF-002 = 0 to 34.474bar (= 500PSI) absolute pressure / 0.5 to 4.5V analog output
Packing Form:	RE = Reel
Ordering example:	MLX90830-LXZ-BAH-001-RE

MLX90830LXZ-BAH-001-RE



4. Package Diagram



Figure 2: Internal wiring of MLX90830. Top view.

Absolute Pressure Sensor with Analog Output Datasheet





5. General Description

The MLX90830 is a packaged, factory calibrated, absolute pressure sensor measuring spans from 2 to 70 bar. It outputs an analog 'ratiometric' output; the ratio of the output voltage divided by the supply voltage has a linear relationship to the pressure.

The MLX90830 consists of a MEMS pressure sensor element and an interface chip (CMOS technology). This optimized solution exhibits excellent EMC performance. The DSP based signal interface provides outstanding initial accuracy. A smart package and die assembly concept enable high output stability over life, even in stringent automotive temperature and stress conditions.

The MEMS pressure sensor element uses the Triphibian[™] technology; a suspended cantilever design that is inherently more robust than rear-side exposed solutions, which still experience a pressure differential between the glass pedestal side and the wire bonding side. The pressure equalization principle is also valid for frozen media.

Absolute Pressure Sensor with Analog Output Datasheet





Contents

1. Features and Benefits	1
2. Application Examples	1
3. Ordering information	2
4. Package Diagram	2
5. General Description	3
6. Glossary of terms	5
7. Absolute Maximum Ratings	6
8. Pin Definitions and Descriptions	7
9. General Electrical Specifications	8
10. Detailed General Description	9
11. Default programmed settings	10
11.1. MLX90830-LXZ-BAH-001	11
11.2. MLX90830-LXZ-BAF-002	11
11.3. Diagnostics	12
11.4. Broken Connection Diagnostics	12
11.5. Internal Diagnostics	12
12. Digital	13
13. Application Information	13
14. Package Information, IC handling and assembly	14
14.1. Package information	14
14.2. Storage and handling of plastic encapsulated ICs	15
14.3. Assembly of encapsulated ICs	15
14.4. Environment and sustainability	15
15. Revision history	16
16. Disclaimer	17

Absolute Pressure Sensor with Analog Output Datasheet





6. Glossary of terms

Term	Description
ADC	Analog to Digital Converter
ASIL	Automotive Safety Integrity Level
Bar	Pressure unit (1bar = 100kPa)
DSP	Digital Signal Processor
EMC	Electro Magnetic Compatibility
ESD	Electrostatic discharge
FS	Output Full Scale = O2 – O1
GND	Ground connection
Lower fault band	Output voltage below normal output range to indicate a diagnostic
NC	Not Connected
NVM	Nonvolatile memory
OV	Over Voltage
PCB	Printed Circuit Board
POR	Power-on Reset
PTC04	Melexis Programming Tool, hardware to program the device in lab or production
RV	Reverse Voltage
SEooC	Safety Element out of Context
T _A	Ambient temperature
TEST	Test pin
Upper Fault Band	Output voltage above normal output range to indicate a diagnostic
UV	Under Voltage
Vaux	Pin to connect an auxiliary capacitor
Vsup	Supply pin

Table 1: Glossary of terms

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Absolute Pressure Sensor with Analog Output Datasheet

7. Absolute Maximum Ratings

Parameter	Symbol	Value	Units	Comment
Supply Voltage (overvoltage)	OV	40	V	
Reverse Voltage Protection	RV	-40	V	Max 2 hours
Positive output voltage		40	V	IVIAX 2 HOUIS
Reverse output voltage ⁽¹⁾		-40	V	
Operating Ambient Temperature Range	T _A	-40 to 150	°C	
Storage Temperature Range		-40 to 150	°C	
Programming Ambient Temperature Range		-40 to 125	°C	
Proof pressure		3x P2	Bar	
Burst pressure		5x P2	Bar	

Table 2: Absolute maximum ratings

Exceeding the absolute maximum ratings may cause permanent damage. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. Maximum duration of over voltage and reverse voltage conditions is 2 hours.

1 Absolute maximum DC negative output at floating supply or supply shorted to output. Maximum DC negative output at operating supply: -5.5V.





Absolute Pressure Sensor with Analog Output Datasheet

8. Pin Definitions and Descriptions

Pin number	Description	Pin number	Description
1	Not connected	16	Not connected
2	Not connected	15	Not connected
3	Ground	14	Ground
4	Not connected	13	VAUX
5	Not connected	12	TEST
6	Ground	11	Ground
7	VSup	10	TEST
8	Analog OUT	9	TEST

Table 3:	Pin out	definitions	and	descriptions
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Figure 3: Package marking (Top view)

Symbol	Function / Description
XXXXXX	ASIC lot number
ZZZZZZ	Sub-lot number
YY	Year of assembly
WW	Calendar week of assembly
AAA	MEMS and ASIC traceability letter

Table 4: Package marking definition

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Absolute Pressure Sensor with Analog Output Datasheet

9. General Electrical Specifications

DC Operating Parameters T_A = -40°C to 150°C

Parameter	Symbol	Remarks	Min	Typ ⁽²⁾	Max	Units
Nominal supply voltage	Vdd		4.5	5	5.5	V
Nominal supply current	Idd	No output load		9.5	12	mA
Current consumption at	IDD_OV				20	mA
supply overvoltage						
Current consumption at	IDD_RV				20	mA
supply reverse voltage						
Output short-circuit	IOUT_SH				20	mA
current						
Capacitive load on	Cload		47		220	nF
output						
Resistive load on output	Rload	Pull up	3		425	kOhm
Resistive load off output	NIUdu	Pull down	3		470	kOhm
Output current	IOUT				2	mA
Under voltage detection		Programmable. In default	4.15		4.8	V
range		configuration set to 4.2V.				
Over voltage detection		Programmable. In default	5.2		5.75	V
range		configuration set to 5.55V.				
Under voltage detection			-50		50	mV
tolerance						
Over voltage detection			-50		50	mV
tolerance						
Power up time		Time from reaching minimum allowed supply voltage of 4.5V till having the output within specification			4	ms
Default response time ⁽³⁾		According to default configuration.			1	ms
Fastest response time ⁽³⁾					0.4	ms
Refresh rate		Time between two consecutive updates on the output			75	μs
Operating output		Output range where the linearity	4		96	%Vdd
voltage range		is in spec with any resistive load inside the specified range				
Upper Fault Band			97		100	%Vdd
Lower Fault Band			0		3	%Vdd
Pressure output noise		Default configuration			2	mV rms

Table 5: Electrical specifications

3 Response time is defined as the time elapsed from input pressure step to the output reaching 90% of settled output.

² Typical values are defined at $T_A = +25 \circ C$ and $V_{DD} = 5V$.

Absolute Pressure Sensor with Analog Output Datasheet

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10. Detailed General Description

The MLX90830 consists of a pressure sensor element and a DSP-based interface chip.

The pressure sensor element consists of a diaphragm realized in the silicon chip by wafer bonding on an etched cavity with built in reference vacuum. The diaphragm reacts to a change in absolute pressure. The internal strain increases, in particular at the border of the diaphragm. Here, the piezo-resistive elements have been implanted into the silicon diaphragm forming a Wheatstone bridge, which act as a transducer. The pressure sensor element can operate in gas and liquid media or a mix of both.

The sensor uses Triphibian[™] technology: a suspended cantilever design of the sensor provides pressure spike immunity up to 2000 bar/msec and static burst level up to 210 bar. The MLX90830's design is inherently more robust than rear-side exposed solutions, which still experience a pressure differential between the glass pedestal side and the wire bonding side. The pressure equalization principle is also valid for frozen media.

The analog front-end of the interface chip applies filtering and converts the analog signal to a digital value. The DSP performs the compensations over temperature. Furthermore, the digital circuit provides some filtering, the possibility to linearize the pressure signal and also implements the clamping function. This chip has an analog output proportional to the pressure and supply voltage. A broken wire detection block ensures the analog output goes to one of the fault bands in case of a broken supply or ground connection.

Extensive protection of the supply lines and output allows the MLX90830 to handle extreme overvoltage conditions and makes it resistant to severe external disturbances. Several diagnostic functions (over-voltage, under-voltage, overpressure, under pressure detections) have been implemented on the MLX90830 and can be enabled by programming EEPROM settings. Figure 4 shows the MLX90830 block diagram.



Figure 4: MLX90830 block diagram





Absolute Pressure Sensor with Analog Output Datasheet

11. Default programmed settings

The MLX90830 is calibrated at the final manufacturing test steps. During the calibration, settings are stored in the on-chip EEPROM to define the pressure transfer curve.



Figure 5: Pressure transfer function and accuracy at room temperature



Figure 6: Pressure accuracy temperature factor

Absolute Pressure Sensor with Analog Output Datasheet





11.1. MLX90830-LXZ-BAH-001

Transfer Curve Parameter	Symbol	Remarks	Value			Unit
Pressure 1	P1	See Figure 5: Pressure		0		Bar
Pressure 2	P2	transfer function and	-	L0.342		Bar
Output 1	01	accuracy at room temperature		0.5		V
Output 2	02			4.5		V
Low clamping level	LCL			0.3		V
High clamping level	HCL			4.7		V
Pressure Accuracy Parameter	Symbol	Remarks	Min	Тур	Max	Unit
Output accuracy	ε٥	Overall accuracy expressed as output value (FS range from 0.5 to 4.5V)	-20 -0.5		20 0.5	mV %FS
Pressure accuracy	ε _p	Overall accuracy expressed as pressure value	-52		52	mBar
Center temperature accuracy factor	Fc	See Figure 6: Pressure accuracy temperature factor			1	
Extended temperature accuracy factor	Fe				1.25	

Table 6: BAH-001 Default configuration

11.2. MLX90830-LXZ-BAF-002

Transfer Curve Parameter	Symbol	Remarks	Value			Unit
Pressure 1	P1	See Figure 5: Pressure		0		Bar
Pressure 2	P2	transfer function and	3	34.474		Bar
Output 1	01	accuracy at room temperature		0.5		V
Output 2	02			4.5		V
Low clamping level	LCL			0.3		V
High clamping level	HCL			4.7		V
Pressure Accuracy Parameter	Symbol	Remarks	Min	Тур	Max	Unit
Output accuracy	ε _o	Overall accuracy expressed as output value (FS range from 0.5 to 4.5V)	-20 -0.5		20 0.5	mV %FS
Pressure accuracy	ε _ρ	Overall accuracy expressed as pressure value	-172		172	mBar
Center temperature accuracy factor	Fc	See Figure 6: Pressure accuracy temperature factor			1	
Extended temperature accuracy factor	Fe				1.25	

Table 7: BAF-002 Default configuration

Absolute Pressure Sensor with Analog Output Datasheet





11.3. Diagnostics

The MLX90830 has built in diagnostics which can flag fault conditions. This is done by having an output set to 0V or 5V, this is beyond the upper and lower clamp levels of a valid output signal. There are two groups. The first is the broken connection diagnostic which triggers when the device is connected incorrectly. The second group consists of the internal diagnostics, these are used to flag abnormal states during operation.

11.4. Broken Connection Diagnostics

Table 8 shows the output behavior of the MLX90830 if a connection is broken or incorrect.

GND	VDD	Analog out	Effect on output	Action after wrong connection
0V	5V	Pull-down or Pull-up	Normal operation	Normal operation
Disconnected	5V	Pull-down or Pull-up	Lower Fault Band for Pull-down Upper Fault Band for Pull-up	Normal operation
OV	Disconnected	Pull-down or Pull-up	Low Fault Band for Pull-down Upper Fault Band for Pull-up	Normal operation
OV	5V	Disconnected	Low Fault Band for Pull-down Upper Fault Band for Pull-up	Normal operation
0V	5V	0V	Low Fault Band	Normal operation
0V	5V	5V	Upper Fault Band	Normal operation

Table 8: Broken connections

11.5. Internal Diagnostics

The MLX90830 has several internal checks which monitor the status of the device. These checks or diagnostic sources can be enabled or disabled based on the sensor module requirements. It's possible to separately define some sources to appear as a Low Fault Band error and others as a High Fault Band. Table 9 shows the available diagnostic sources which can be programmed to result in either a high fault band output or low fault band output.

Bit	Error condition	Default settings
0	Supply voltage too high Disabled	
1	Supply voltage too low	Disabled
2	Internal error	Lower Fault Band
3	Broken pressure membrane	Lower Fault Band
4	Pressure parameter error	Lower Fault Band
5	Pressure output error	Lower Fault Band
6	Internal regulator out of range	Disabled

Table 9: Diagnostic sources

Absolute Pressure Sensor with Analog Output Datasheet





12. Digital

The digital is built around a 16-bit microcontroller. It contains besides the processor also ROM, RAM and EEPROM and a set of user and system IO registers. Temperature compensation of the pressure signal and pressure linearization is handled by the microcontroller. For the pressure compensation there are EEPROM parameters allocated to be able to cover a large variety of calibration approaches.

Both for gain and offset of the pressure signal, there is a separate temperature dependency which is programmable up to a third order compensation. This is reflected in EEPROM parameters for the offset (O0, O1, O2 and O3) and for the gain (G0, G1, G2 and G3).

If required, the linearity of the pressure signal can also be compensated with a first order temperature dependency through EEPROM parameters LO and L1.

13. Application Information

Below recommendations for external components are providing basic EMC/ESD protection. Depending on the module design and the EMC/ESD requirements, alternative configurations can be necessary.



Figure 7: Application schematic (top view). The dark lines are needed connections, the grey lines are recommended connections for better EMC.

Absolute Pressure Sensor with Analog Output Datasheet

14. Package Information, IC handling and assembly

14.1. Package information



Figure 8: MLX90830 package drawing



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Both dimensions are determined at

ackage top may be smaller than the package bottom. Both dimensions are determined at most extremes of the plastic body, exclusive of mold flash, tie bar burrs, gate burrs and and flash, but including any mismatch between top and bottom of the plastic body

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REVISION 002 - 20 DECEMBER 2024

Absolute Pressure Sensor with Analog Output Datasheet





14.2. Storage and handling of plastic encapsulated ICs

Plastic encapsulated ICs shall be stored and handled according to their MSL categorization level (specified in the packing label) as per J-STD-033.

Electronic semiconductor products are sensitive to Electro Static Discharge (ESD). The component assembly shall be handled in EPA (Electrostatic Protected Area) as per ANSI S20.20

For more information refer to Melexis <u>Guidelines for storage and handling of plastic encapsulated ICs</u>⁽⁴⁾

14.3. Assembly of encapsulated ICs

For Surface Mounted Devices (SMD, as defined according to JEDEC norms), the only applicable soldering method is reflow.

For Through Hole Devices (THD), the applicable soldering methods are reflow, wave, selective wave and robot point-to-point. THD lead pre-forming (cutting and/or bending) is applicable under strict compliance with Melexis *Guidelines for lead forming of SIP Hall Sensors*⁽⁴⁾.

Melexis products soldering on PCB should be conducted according to the requirements of IPC/JEDEC and J-STD-001. Solder quality acceptance should follow the requirements of IPC-A-610.

For PCB-less assembly refer to the relevant application notes ⁽⁴⁾ or contact Melexis.

Electrical resistance welding or laser welding can be applied to Melexis products in THD and specific PCB-less packages following the <u>Guidelines for welding of PCB-less devices</u>⁽⁴⁾.

Environmental protection of customer assembly with Melexis products for harsh media application, is applicable by means of coating, potting or overmolding considering restrictions listed in the relevant application notes ⁽⁴⁾

For other specific process, contact Melexis via www.melexis.com/technical-inquiry

14.4. Environment and sustainability

Melexis is contributing to global environmental conservation by promoting non-hazardous solutions. For more information on our environmental policy and declarations (RoHS, REACH...) visit www.melexis.com/environmental-forms-and-declarations

⁴ <u>www.melexis.com/ic-handling-and-assembly</u>

Absolute Pressure Sensor with Analog Output Datasheet





15. Revision history

Revision	Date	Change history
001	17-01-2024	Creation of document
002	20-12-2024	Update of package code

Absolute Pressure Sensor with Analog Output Datasheet





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3. defense related products, or other material for military use or for law enforcement;

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